06/27/05 MON 17:23 FAX 886 2 23697233

JIANQ CHYUN IPO

JUN 27 2005

**2**001

**Patent** 

Custom No.: 31561 Docket No.: 10796-US-PA

Application No.: 10/710,344

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Applicant

: Ho et al.

Application No.

: 10/710,344

Filed

: 2004/7/2

For

: CHIP PACKAGE STRUCTURE

Art Unit

: 2826

Examiner

: Quinto, Kevin V

#### TRANSMITTAL LETTER

002-1-703-872-9306 (Via fax: 1+6 pages)

**Assistant Commissioner for Patents** Alexandria, VA 22314

Dear Sir,

In response to the Office Action dated March 28, 2005(Paper No.: 20050305), please find the Response to Office Action, in 6 pages.

I believe that no fee is incurred. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No.: 10796-US-PA).

Thank you for your assistance in the subject matter. If you have any questions, please feel free to contact me.

> Respectfully Submitted, JIANQ CHYUN Intellectual Property Office

Date: Tul 27, Sells

Registration No.: 46,863

Please send future correspondence to:

7F. -1, No. 100, Roosevelt Rd.,

Sec. 2, Taipei 100, Taiwan, R.O.C.

Tel: 886-2-2369 2800

Fax: 886-2-2369 7233 / 886-2-2369 7234

E-MAIL: BELINDA@JCIPGroup.com.tw; USA@JCIPGroup.com.tw

# RECEIVED CENTRAL FAX CENTER JUN 2 7 2005

Customer No.: 31561 Docket No.: 10796-US-PA Application No.: 10/710,344

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

| In Re Application of:       | )                         |
|-----------------------------|---------------------------|
| HO, Ming-Lun et al.         | Examiner: QUinto, Kevin V |
| Serial No.: 10/710,344      | ) Art Unit: 2826          |
| Filed: 07/02/2004           | Docket No.: 10796-US-PA   |
| For: Chip Package Structure | <b>)</b>                  |

No fee is believed to be due in connection with this amendment and response to Office Action. If, however, any fee is believed to be due, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (order No. 10796-US-PA).

## AMENDMENT AND RESPONSE TO OFFICE ACTION

United States Patent and Trademark Office Customer Service Window Mail Stop <u>Amendment</u> Randolph Building 401 Dulany Street Alexandria, VA 22314

Sir:

The Office Action dated March 28, 2005, has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.

Customer No.: 31561 Docket No.: 10796-US-PA Application No.: 10/710,344

#### **AMENDMENTS**

#### In The Title

Please amend the Title by replacing with

--CHIP PACKAGE STRUCTUR WITH DUAL HEAT SINKS-